iStar sCMOS
Ultrafast Platform for Nanosecond Time-resolved Imaging and Spectroscopy

Key Specifications
- 5.5 megapixel sCMOS
- 50 fps full frame
- High dynamic range at full speed
- Integrated triple output DDG
- Photocathode QE up to 50%
- Integrate-On-Chip gating up to 500 kHz
- USB 3.0 interface

Key Applications
- Plasma studies
- Time-resolved Fluorescence & Photoluminescence
- Flow analysis
- Combustion/PLIF imaging
- Hyperspectral imaging
- Standoff chemical detection

andor.oxinst.com
Introducing iStar sCMOS

Superior high-speed acquisition performance

- 1-bit high-speed mode
- 2 times faster than the closest interline-based competitor at an equivalent field-of-view (and over 5 times faster with ROI)

Market Leading Ultrafast Acquisition Speeds

<table>
<thead>
<tr>
<th>Image Array Size</th>
<th>Frame Rate 12-bit (fps)</th>
</tr>
</thead>
<tbody>
<tr>
<td>2560 x 2560</td>
<td>50 (50)</td>
</tr>
<tr>
<td>2048 x 2048</td>
<td>52 (52)</td>
</tr>
<tr>
<td>2560 x 1800 (38 mm tube fit)</td>
<td>59 (59)</td>
</tr>
<tr>
<td>512 x 512</td>
<td>203 (203)</td>
</tr>
<tr>
<td>128 x 128</td>
<td>736 (736)</td>
</tr>
<tr>
<td>2560 x 8</td>
<td>4,008 (4,008)</td>
</tr>
</tbody>
</table>

Delivers

- Faster characterisation of transient plasma, fluorescence or absorption behaviours
- NEW Faster characterization of spectroscopic phenomena and multi point experiment studies (multi-track)
- Faster Echellegram image capture for broadband LIBS-based applications

Application Focus

Flow Analysis / Combustion

iStar sCMOS comfortably accommodates the 15 Hz imaging requirement of typical PLIF setups with extremely low noise floor and excellent dynamic range. Nanosecond snapshots of the flame and high background light rejection. Optical inter-frame down to 200 ns for time-gated PIV setups with a wide range of velocities.

Plasma Imaging

The high frame rate and < 2 ns gating of the iStar sCMOS allow faster reconstruction of plasma dynamics with extremely high temporal resolution.

Hyperspectral Imaging & multi-track spectroscopy

On-board FPGA functions can discriminate up to 256 individual channels (e.g. multi-leg fibre optic) with no acquisition rate sacrifice compared to CCDs, for time-gated PIV setups with a wide range of velocities.

Features & Benefits

<table>
<thead>
<tr>
<th>Feature</th>
<th>Benefit</th>
</tr>
</thead>
<tbody>
<tr>
<td>50 frames/s acquisition rates</td>
<td>Sustainable rate of full field-of-view, out-performs CCD and interline based ns gated ICCDs with equivalent field-of-view.</td>
</tr>
<tr>
<td>16.6 x 14.0 mm sensor matrix</td>
<td>Large field of view, access more of the useful active area of Ø11.8 mm image intensifiers without the need for optical tapers.</td>
</tr>
<tr>
<td>2.4 e- read noise</td>
<td>Highest dynamic range even at the fastest frame rates, up to 5 times better performance than the closest interline-based competitor.</td>
</tr>
<tr>
<td>12-bit and 16-bit modes</td>
<td>12-bit mode for smaller file size and absolute fastest frame rates. 16-bit for full dynamic range.</td>
</tr>
<tr>
<td>Up to 32-bit data transmission to PC</td>
<td>On-head intelligence to preserve dynamic range in extensive pixel binning. Or high intensity pixel binning scenarios.</td>
</tr>
<tr>
<td>Optical inter-frame down to 300 ns</td>
<td>Ideal for PIV-type applications requiring fast dual images snapshots with high background rejection or supercontinuum analysis. The true Global Shutter mode facilitates an optical inter-frame gap down to 100 ns although the intensifier phosphor decay time is the limiting factor. The decay time of a fast P46 phosphor is typically 200 ns (@ 10% intensity).</td>
</tr>
<tr>
<td>TE cooling down to 0°C</td>
<td>Efficiently minimizes dark current noise for acquisitions requiring longer sensor exposure time. e.g. integrate-on-chip mode.</td>
</tr>
<tr>
<td>High QE Gen 2 &amp; 3 image intensifiers</td>
<td>Superior photon capture, with peak QE up to 50% and spectral coverage from 120 to 1,100 nm.</td>
</tr>
<tr>
<td>True optical gating &lt; 2 ns</td>
<td>Billions of a second time-resolution for accurate transient phenomena study.</td>
</tr>
<tr>
<td>Low Jitter, on-board Digital Delay Generator (DDGTM)</td>
<td>Highest gating timing accuracy with lowest propagation delay. Software controlled 3x triggering outputs with 10 ps setup accuracy for complex experiment integration.</td>
</tr>
<tr>
<td>500 kHz sustained photocathode gating (3.3 MHz Burst Mode)</td>
<td>Maximizes signal-to-noise ratio in high repetition rate pulse laser-based applications. Burst mode allows gate pulse separation down to 300 ns for time-resolved PV mode.</td>
</tr>
<tr>
<td>Photocathode EBI minimization</td>
<td>Dry gas purge interface for further efficient EBI reduction.</td>
</tr>
<tr>
<td>Intelligator™</td>
<td>Intelligent and accurate MCP gating for better than 1:100 shuttering efficiency in the UV (Gen 2 image intensifier).</td>
</tr>
<tr>
<td>USB 3.0 interface</td>
<td>Super-fast data transfer at 40 fps full frame with a plug-and-play, user-friendly interface - optical extenders available for operation up to 100 m.</td>
</tr>
<tr>
<td>GPU Express</td>
<td>Simplify and optimize data transfers from camera to Graphical Processing Unit (GPU) card to facilitate accelerated GPU processing as part of the acquisition pipeline.</td>
</tr>
<tr>
<td>Integrated in EPICS</td>
<td>Ease of operation in EPICS software-based facilities such as partner particle accelerators and other large scientific experiments.</td>
</tr>
<tr>
<td>2 year warranty</td>
<td>Reliability and guaranteed performance over time.</td>
</tr>
</tbody>
</table>

Spectroscopy Modes

- On-head asymmetric binning and multi-track
  - On-board intelligence delivering Spectroscopists-friendly spectra and multi-track data prior to transfer through USB interface. Upfront data size reduction and easier user data processing.
  - Selectable bit-depth up to 32-bit
  - Preserve dynamic range in extensive on-head binning scenarios. User-selectable data bit depth to be transmitted over the camera interface. up to 32-bit.
Technical Specifications

### Sensor type
Front-Illuminated Scientific CMOS

### Sensor matrix
2560 x 2160 pixels (W x H), 6.5 µm pixel size

### Sensor size
16.6 x 14.0 mm (W x H), 21.8 mm diagonal

### Pixel well depth (e-)
30,000

### Read noise (e-)
- @ 200 MHz: 2.3 [2.5]
- @ 560 MHz: 2.4 [2.6]

### Minimum cooling temperature
- [dark current, e- /pixel/s] (°C)
  - air cooled: 0°C [0.18]
  - liquid cooled: 0°C [0.18]

### Sensor linearity (% maximum)
Better than 99.8%

### Data range
- 12-bit (fastest speed)
- 16-bit (maximum dynamic range)

### Pixel binning
On-head, pre-defined options 2x2, 4x4… or flexible configuration setup

### Region of Interest
Minimum channel height of 8 rows

### Interface option
USB 3.0

### Internal memory
1 GB

### Camera and Internal Digital Delay Generator (DDG) Inputs/Outputs

#### Gate pulse delay & width
Adjustable from 0 ns to 10 s in 10 ps steps

#### Trigger Outputs
- Output A, B and C: +5 V CMOS level with 50 Ω source impedance, can drive 5 V into a non-terminating load or 2.5 V into 50 Ω load output synchronized triggers for auxiliary equipment, e.g. lasers, flash lamps. National Instrument™ hardware individual delay control from 0 ns to 10 s in 10 ps steps
- Fire: 5 V CMOS level reference signal for beginning and end of individual sensor exposure
- Arm monitor: 5 V CMOS level reference signal to indicate when system is ready to accept external triggers. Signal goes high when system is ready to accept external triggers (after a readout has finished or sooner if in overlap mode) and goes low when the exposure is finished

#### Gate & output A, B and C jitter
35 ps rms (relative to external trigger or to each other)

#### Trigger Inputs
- External trigger: Trigger input for sensor and Digital Delay Generator
- Direct gate: TTL input for exact external control of photocathode width and timing with smallest insertion delay

#### Additional Controls
- Gate monitoring: AC coupling from photocathode to monitor exact photocathode on/off switching and timings
- Insertion delay: < 19 ns in direct gate operation

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### How the sCMOS sensor is used in the different modes

#### Imaging Mode
- The array size may be defined for either resolution, or maximum speed.

#### Spectroscopy Mode
- A vertically binned track is defined on the sensor enabling the maximum spectral rate to capture dynamic events.

#### Multi-track Mode
- Up to 256 vertically binned tracks can be used for multi-track analysis without sacrificing speed.

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### GPU Express - Optimise Data Flow-Rates

The Andor GPU Express library has been created to simplify and optimise data transfers from camera to a CUDA-enabled Nvidia Graphical Processing Unit (GPU) card to facilitate accelerated GPU processing as part of the acquisition pipeline. GPU Express integrates easily with SDK3 for Windows, providing a user-friendly but powerful solution for management of high bandwidth data flow challenges; ideal for data intensive applications such as Light Sheet Microscopy, Super-Resolution Microscopy and Adaptive Optics.

- Enhanced convenience, afforded by simple, optimised GPU data management
- Optimal data throughout
- Superb, easily accessible documentation and examples.
Quantum Efficiency Curves for Gen 2 Image Intensifiers

<table>
<thead>
<tr>
<th>Photocathode model</th>
<th>18*-03 (P43)</th>
<th>18*-04 (P46)</th>
<th>18H-13 (P43)</th>
<th>18H-14 (P46)</th>
<th>18H-83 (P43)</th>
<th>18H-84 (P46)</th>
<th>18*-E3 (P43)</th>
<th>18*-E4 (P46)</th>
<th>25*-03 (P43)</th>
<th>25*-04 (P46)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Useable aperture</td>
<td>Ø18 mm (Ø25 mm available - contact Andor for information)</td>
<td>Ø18 mm only</td>
<td>Ø25 mm only</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input window</td>
<td>Quartz (Ø18 mm)</td>
<td>MgF₂ (Ø18 mm)</td>
<td>Quartz (Ø25 mm)</td>
<td>Quartz (Ø25 mm)</td>
<td>Quartz (Ø25 mm)</td>
<td>Quartz (Ø25 mm)</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Photocathode type</td>
<td>W-AGT (Ø18 mm)</td>
<td>W-AGT (Ø25 mm)</td>
<td>W-AGT (Ø18 mm)</td>
<td>W-AGT (Ø25 mm)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Minimum guaranteed QE at room temperature</td>
<td>13.5%</td>
<td>11%</td>
<td>7%</td>
<td>20%</td>
<td>15%</td>
<td>14%</td>
<td>13.5%</td>
<td>11%</td>
<td>7%</td>
<td>20%</td>
</tr>
<tr>
<td>Typical peak QE at room temperature</td>
<td>&gt;18%</td>
<td>&gt;15%</td>
<td>&gt;13.5%</td>
<td>&gt;25%</td>
<td>&gt;22%</td>
<td>&gt;16%</td>
<td>&gt;18%</td>
<td>&gt;15%</td>
<td>&gt;13.5%</td>
<td>&gt;25%</td>
</tr>
</tbody>
</table>

Phosphor type (decay time to 10%) Standard: P43 (2 ms) P46 (200 ns); Optional: P43 (2 ms) P46 (200 ns)

Image intensifier resolution limit (µm):
- 25 µm (Ø18 mm)
- 30 µm (Ø25 mm)

Minimum optical gate width (ns):
- U (Ultrafast)
- F (Fast)
- H (High QE)

Maximum relative gain (x1000):
- P43 (Standard)
- P46 (Optional)

Equivalent Background Illuminance (EBI) (photoe- /pix/sec):
- < 0.2 photoe- /pix/sec
- < 0.4 photoe- /pix/sec
- < 0.2 photoe- /pix/sec

1 Substitute with appropriate gate width option, e.g. 18*-03 (please refer to page 9 for detailed ordering information)

Quantum Efficiency Curves for Gen 3 Image Intensifiers

<table>
<thead>
<tr>
<th>Photocathode model</th>
<th>18*-83 (P43)</th>
<th>18*-84 (P46)</th>
<th>18*-93 (P43)</th>
<th>18*-94 (P46)</th>
<th>18*-A3 (P43)</th>
<th>18*-A4 (P46)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Useable aperture</td>
<td>Ø18 mm (Ø25 mm options also available except -93 model - contact Andor for information)</td>
<td>Ø18 mm only</td>
<td>Ø25 mm only</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input window</td>
<td>Glass (Ø18 mm)</td>
<td>Glass (Ø25 mm)</td>
<td>Glass (Ø18 mm)</td>
<td>Glass (Ø25 mm)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Photocathode type</td>
<td>HVS (Ø18 mm)</td>
<td>VHV (Ø25 mm)</td>
<td>NIR (Ø18 mm)</td>
<td>EVS (Ø25 mm)</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Minimum guaranteed QE at room temperature</td>
<td>38%</td>
<td>23%</td>
<td>0.10%</td>
<td>35%</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Typical peak QE at room temperature</td>
<td>&gt; 50%</td>
<td>&gt; 30%</td>
<td>&gt; 5%</td>
<td>&gt; 40%</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Wavelength range (nm)</td>
<td>280 - 750 nm</td>
<td>280 - 910 nm</td>
<td>380 - 1090 nm</td>
<td>280 - 810 nm</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Phosphor type (decay time to 10%) Standard: P43 (2 ms) P46 (200 ns); Optional: P43 (2 ms) P46 (200 ns)

Image intensifier resolution limit (µm):
- 25 µm (Ø18 mm)
- 30 µm (Ø25 mm)

Minimum optical gate width (ns):
- U (Ultrafast)
- F (Fast)

Maximum relative gain (x1000):
- > 200 (P43)
- > 100 (P46)

500 kHz (continuous)

Quantum Efficiency Curves for Gen 3 Image Intensifiers
Intelligent gating modes

Integrate-On-Chip: 500,000 times more signal per 1 sec sensor exposure

The iStar’s Integrate-On-Chip (IOC) mode enables accumulation of useful signal from laser-induced phenomena at frequencies up to 500 kHz, providing greatly improved signal-to-noise, and minimising experiment time. The latter greatly benefits setups where photobleaching-sensitive biological samples are probed. This translates into the possibility to accumulate 500,000 times more signal per 1 second sensor exposure time.

Integrate-On-Chip is fully software-configurable and can be used through extensive kinetic series involving up to 1,000 pre-programmed incremental delays from laser trigger for unrivalled combination of sensitivity and ultra-precise transient phenomena analysis.

Intelligate™: Superior gating in the UV-VUV region

One of the key functions of an image intensifier is to provide high optical shuttering (ON/OFF) ratio. By switching photocathode voltage to a higher or lower level relative to the MCP, photo-electrons can be either directed towards or repelled from the MCP to avoid detection. ON/OFF values of 1:10⁸ are typically measured for Visible/NIR incident light on the photocathode.

However photocathode “leakage” becomes more pronounced in the UV-VUV region (< 300 nm), where more energetic photons have a greater probability to go through the photocathode turned “OFF”, reach the MCP to generate an electron that can be detected. This can lead to shuttering efficiency as low as 1:10⁴. Andor’s exclusive Intelligate™ simultaneously gates the photocathode and the MCP. The ultra fast rising edge of the MCP gate pulse switches on the correct potential in a nanosecond timeframe, coinciding precisely with the photocathode gating pulse. This enables ON/OFF ratios as high as 10⁸ in the UV-VUV region.

Creating the optimum product for you

Step 1. Choose the intensifier diameter

<table>
<thead>
<tr>
<th>Intensifier diameter</th>
<th>Code</th>
</tr>
</thead>
<tbody>
<tr>
<td>Ø 18 mm</td>
<td>18</td>
</tr>
<tr>
<td>Ø 25 mm</td>
<td>25</td>
</tr>
</tbody>
</table>

Step 2. Choose a minimum gating speed

<table>
<thead>
<tr>
<th>Gating speed</th>
<th>Code</th>
</tr>
</thead>
<tbody>
<tr>
<td>High QE, slow gating</td>
<td>H</td>
</tr>
<tr>
<td>Fast Gating</td>
<td>F</td>
</tr>
<tr>
<td>Ultra Fast Gating</td>
<td>U</td>
</tr>
</tbody>
</table>

Step 3. Select an image intensifier option

<table>
<thead>
<tr>
<th>Intensifier</th>
<th>Gen 2 Intensifier option</th>
<th>Gen 3 Intensifier option</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>P43 phosphor</td>
<td>P46 phosphor</td>
</tr>
<tr>
<td>W-AGT photocathode</td>
<td>O3</td>
<td>HVS photocathode</td>
</tr>
<tr>
<td>W-AGT photocathode, MgF₂</td>
<td>O5</td>
<td>VHR photocathode</td>
</tr>
<tr>
<td>WSI photocathode</td>
<td>13</td>
<td>NIR photocathode</td>
</tr>
<tr>
<td>UW photocathode</td>
<td>83</td>
<td>EVS photocathode</td>
</tr>
<tr>
<td>WE-AGT photocathode</td>
<td>E3</td>
<td>WE-AGT</td>
</tr>
</tbody>
</table>

Step 4. Select the required accessories and adapters

<table>
<thead>
<tr>
<th>Description</th>
<th>Order Code</th>
</tr>
</thead>
<tbody>
<tr>
<td>C-mount lens adaptor</td>
<td>ACC-LM-C</td>
</tr>
<tr>
<td>F-mount lens adaptor</td>
<td>ACC-LM-NIKON-F</td>
</tr>
<tr>
<td>UV-VIS 105mm SIR lens, 250 - 650 nm transmission, F-mount</td>
<td>OL-AF10-F45-#UV2</td>
</tr>
<tr>
<td>Oasis 150 Ultra compact chiller and tubing to be ordered separately</td>
<td>ACC-XW-CHL-160</td>
</tr>
<tr>
<td>6 mm tubing options for ACC-XW-CHL-160 (2x5.2 or 2x5.6 m length)</td>
<td>ACC-9MMTUBING-2X2.5/ACLUMM-2X5M</td>
</tr>
<tr>
<td>1’C to BNC cable for Kymera and Shamrock shutter control</td>
<td>ACC-ISTAR-METRIC ADP</td>
</tr>
<tr>
<td>Metric Bracket, converts ¼-20 mounting points to M6</td>
<td>ELC-05323</td>
</tr>
<tr>
<td>15 m active USB 3.0 connector cable (power supply not required)</td>
<td>ACC-ASE-06887</td>
</tr>
<tr>
<td>50 m fibre optic USB 3.0-extendern solution including power supply</td>
<td>ACC-ASE-08752</td>
</tr>
<tr>
<td>100 m fibre optic USB 3.0-extendern solution including power supply</td>
<td>ACC-ASE-07850</td>
</tr>
</tbody>
</table>

Step 5. Select the required software

The iStar sCMOS requires at least one of the following software options:

Software

Andor SDK3 A software development kit that allows you to control the Andor sCMOS cameras from your own application. Available as 32/64-bit libraries for Windows 8, 8.1 and 10 and Linux. Comppatible with C/C++, LabView and Matlab.

GPU Express Andor GPU Express library has been created to simplify and optimize data transfers from camera to a CUDA-enabled Nvidia Graphical Processing Unit (GPU) card to facilitate accelerated GPU processing as part of the acquisition pipeline. Integrates easily with Andor SDK3 for Windows.
Our Cameras for Spectroscopy

Spectroscopy-based diagnostics in the fields of Material Science, Chemistry, Life Science or Fundamental Physics & Optics rely on the capture and analysis of optical and chemical signatures with a high degree of precision.

Andor’s range of detectors offer a wide range of sensitivity, time-resolution and sensor formats to best suit specific experimental conditions from UV to SWIR, nanosecond to hours time resolution, high photon flux to single photon with super dynamic range and resolution.

**High Sensitivity & Dynamic Range**

- Long exposure
- High sensitivity UV-SWIR
- Large pixel well depths
- High resolution matrix

**Spectrographs & Accessories**

- High modularity
- High resolution
- Intelligent motorisation
- Broadband & high resolution Echelle

**iDus CCD & InGaAs | Newton CCD & EM**

**Shamrock | Kymera | Mechelle**

**kHz Spectral Rates**

- μs to ms time-resolution
- High sensitivity down to single photon
- High resolution matrix

**Extended Multi-fibre Spectroscopy**

- Large area sensors
- Ultrafast scMOS and EMCCD options
- High sensitivity down to single photon

**Newton CCD & EMCCD | iXon EMCCD | ZL41 scMOS | Marana sCMOS**

iKon-M CCD | iXon EMCCD | ZL41 scMOS | Marana sCMOS | iStar CCD & sCMOS

Learn more about our detector range [here](#).
Minimum Computer Requirements:
• 3 GHz Quad Core
• 4GB RAM (increase RAM if to be used for continuous data spooling)
• Hard Drive: Minimum 450 MB/s continuous write
• PCI Express x4 or greater
• Windows (8.1 or 10) or Linux

*See technical note entitled: ‘PC Specifications for sCMOS’

Items shipped with your camera
1 x USB 3.0 PCIe Card and 1 x 3 m USB 3.0 cable
1 x Gate Monitor cable
2 x 2 m BNC to SMA cable
1 x Power supply with mains cable
1 x Quick Start Guide
1 x User guides in electronic format
1 x Individual performance booklet

Operating and Storage Conditions
• Operating Temperature: 0ºC to 40ºC ambient
• Relative Humidity: <70% (non-condensing)
• Storage Temperature: -20ºC to 55ºC

Footnotes: Specifications are subject to change without notice
1. Note that the write speed of the PC hard drive can impose a further restriction to achieving sustained kinetic series acquisition. All frame rates specified are given for non-overlap mode.
2. Figures are typical unless otherwise stated.
3. Readout noise is for the entire system and is taken as a median over the sensor area excluding any regions of blemishes. It is a combination of sensor readout noise and A/D noise.
4. Dark current measurement is taken as a median over the sensor area excluding any regions of blemishes.
5. Linearity is measured from a plot of Signal vs. Exposure Time over the full dynamic range.
6. The On/Off ratio for the ’E3 and E4’ image intensifier in the UV with MCP gating is typically 10^5.
7. Typical photocathode Quantum Efficiency and input window transmission as measured by the tube manufacturer.
8. Typical resolution of the image intensifier tube only, not the overall resolution of the system. As a rough guide, the smallest resolvable FWHM feature will be approximately 4x the sensor pixel size. This is a very important consideration for optical resolution calculations in spectrograph-based systems.
9. Gen 2 High QE (H) option – Photocathode QE is inherently linked to the gating speed of the intensifier. High QE option (H) offers higher peak QE than Ultrafast (U) or Fast (F) intensifiers, while exhibiting minimum gating speed one order of magnitude slower.
10. Actual measured minimum optical gating of the photocathode, reflecting not only the electrical pulse width applied to the photocathode but also its inherent rising time.
11. Gain is software-selectable through a 12-bit DAC and varies exponentially with DAC setting. Value refers to the ratio of max to min intensifier gain as measured for individual cameras. Actual optical gain (count/s photon) for a DAC setting is accessed by the multiplication of the relative gain (at that DAC value) by the minimum system gain (at DAC = 0, sCMOS e-/photon) and divided by the sCMOS sensitivity (sCMOS e-/count). Sensitivities are individually measured and reported for each system.
12. USB 3.0 connection should work with any modern USB 3.0 enabled PC/laptop (provided hard drives or RAM is sufficient to support data rates) as every USB 3.0 port should have its own host controller. iStar sCMOS also ship with a USB 3.0 PCIe card as a means to add a USB 3.0 port to an older PC, or as a diagnostic aid to interoperability issues or to ensure maximum speed.

Operating and Storage Conditions
• Operating Temperature: 0ºC to 40ºC ambient
• Relative Humidity: <70% (non-condensing)
• Storage Temperature: -20ºC to 55ºC

Power Requirements
• Please refer to page 10

Order Today
At Andor we are committed to finding the correct solution for you. With a dedicated team of technical advisors, we are able to offer you one-to-one guidance and technical support on all Andor products.
For a full listing of our local sales offices, please see: andor.oxinst.com/contact

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